



N-Channel 30 V (D-S) Fast Switching MOSFET

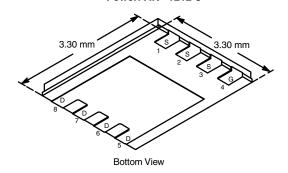
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
30	0.013 at V _{GS} = 10 V	13.3		
	0.015 at V _{GS} = 4.5 V	12.4		
	0.022 at V _{GS} = 2.5 V	10.2		

FEATURES

- Halogen-free According to IEC 61249-2-21 **Available**
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC



PowerPAK® 1212-8

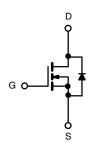


Ordering Information: Si7404DN-T1-E3 (Lead (Pb)-free)

Si7404DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

Li-Ion Battery Protection



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	30		V	
Gate-Source Voltage		V_{GS}	± 12			
Continuous Drain Current (T _{.I} = 150 °C) ^a	$T_A = 25 ^{\circ}C$ $T_A = 70 ^{\circ}C$	I _D	13.3	8.5		
Continuous Diain Current (1) = 150 °C)	T _A = 70 °C		10.6	6.8		
Pulsed Drain Current		I _{DM}	40		Α	
Single Avalanche Current	0.1 mH	I _{AS}	15			
Single Avalanche Energy (Duty Cycle 1 %)	0.11111	E _{AS}		11	mJ	
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3	Α	
Maximum Power Dissipation ^a	T _A = 25 °C		3.8	1.5	w	
Maximum Fower Dissipation	T _A = 70 °C		2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations ^{b,c}			260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian Institute Associated	t ≤ 10 s	- R _{thJA}	26	33		
Maximum Junction-to-Ambient ^a	Steady State		65	81	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{th.IC}	1.9	2.4		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishav.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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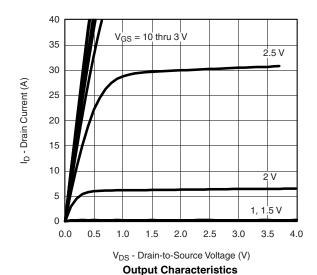
MOSFET SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Min. Typ.		Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.6		1.5	٧	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	1	V _{DS} = 30 V, V _{GS} = 0 V			1	μΑ	
	I _{DSS}	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
		V _{GS} = 10 V, I _D = 13.3 A		0.010	0.013		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 12.4 \text{ A}$		0.0125	0.015	Ω	
		$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		0.019	0.022		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 5 V, I _D = 13.3 A		50		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 3.2 A, V _{GS} = 0 V		0.75	1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			20	30		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 13.3 \text{ A}$		5.8		nC	
Gate-Drain Charge	Q_{gd}			7.1			
Turn-On Delay Time	t _{d(on)}			27	40		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω $I_D \cong$ 1 A, V_{GEN} = 4.5 V, R_G = 6 Ω		39	60	ns	
Turn-Off DelayTime	t _{d(off)}			64	100		
Fall Time	t _f			33	50		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 3.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		45	90		

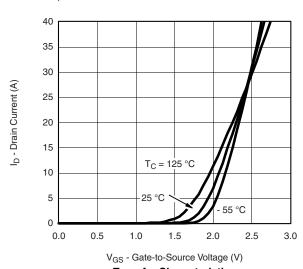
Notes:

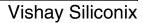
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

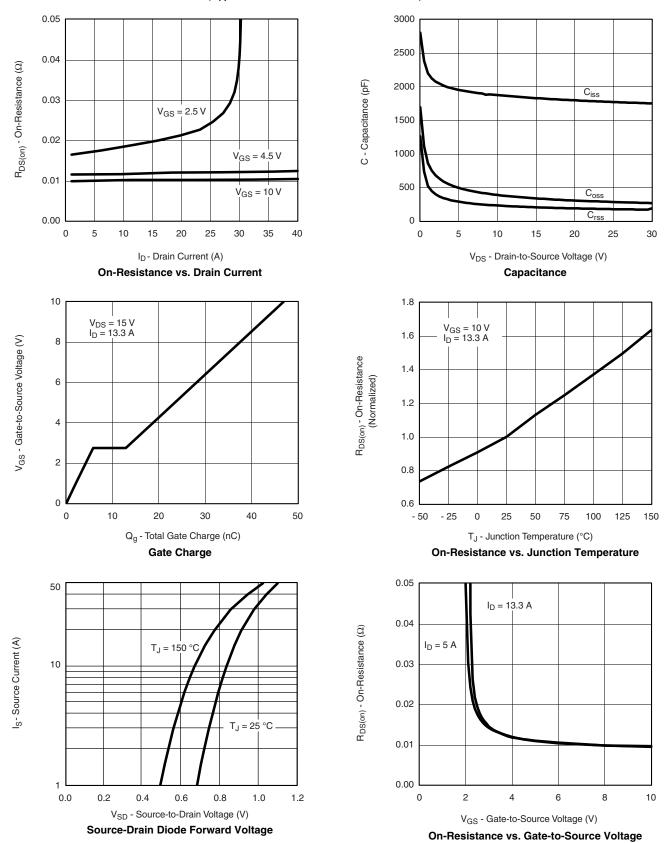






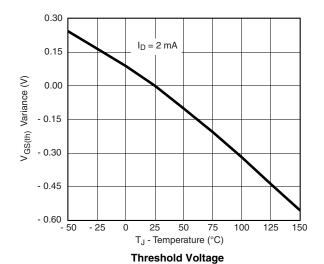


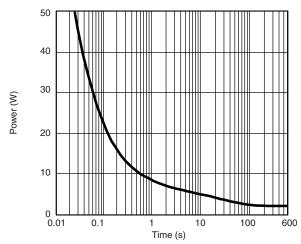
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



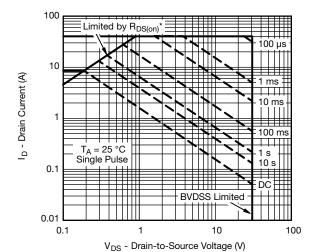
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)





Single Pulse Power, Junction-to-Ambient

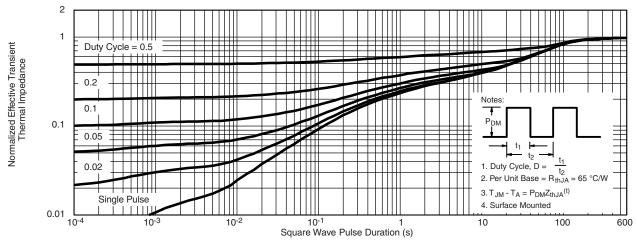


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

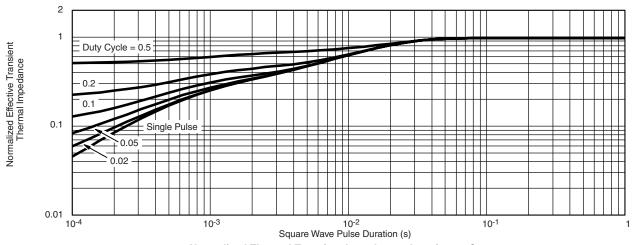
Safe Operating Area, Junction-to-Ambient



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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